

## Surface-Mount Standard Rectifiers

### eSMP® Series



Top view

Bottom view

### SMF (DO-219AB)

Cathode  Anode

### LINKS TO ADDITIONAL RESOURCES



3D Models


**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

### FEATURES

- Low profile package
- Ideal for automated placement
- Oxide planar chip junction
- Low forward voltage drop, low leakage current
- ESD capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Wave and reflow solderable
- AEC-Q101 qualified available  
- Automotive ordering code: base P/NHM3
- Compatible to SOD-123W package case outline
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)

### TYPICAL APPLICATIONS

General purpose, power line polarity protection, in commercial, industrial, and automotive applications.

### MECHANICAL DATA

#### Case: SMF (DO-219AB)

Molding compound meets UL 94 V-0 flammability rating  
Base P/N-M3 - for, halogen-free, and RoHS-compliant

Base P/NHM3 - for halogen-free, RoHS-compliant, and AEC-Q101 qualified

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

**Polarity:** color band denotes the cathode end

### PRIMARY CHARACTERISTICS

$I_{F(AV)}$	2.0 A
$V_{RRM}$	200 V, 400 V, 600 V
$I_{FSM}$	35 A
$V_F$ at $I_F = 2.0$ A ( $T_A = 125$ °C)	0.85 V
$I_R$	5 $\mu$ A
$T_J$ max.	175 °C
Package	SMF (DO-219AB)
Circuit configuration	Single

### MAXIMUM RATINGS ( $T_A = 25$ °C unless otherwise noted)

PARAMETER	SYMBOL	SE20FD	SE20FG	SE20FJ	UNIT
Device marking code		CD	CG	CJ	
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	200	400	600	V
Maximum DC forward current	I <sub>F(AV)</sub> <sup>(1)</sup>	2.0			A
	I <sub>F(AV)</sub> <sup>(2)</sup>	1.7			
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	35			A
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +175			°C

#### Notes

(1) Mounted on 10 mm x 10 mm pad areas, 2 oz. FR4 PCB

(2) Free air, mounted on recommended copper pad area

**ELECTRICAL CHARACTERISTICS** ( $T_A = 25\text{ }^{\circ}\text{C}$  unless otherwise noted)

PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	$I_F = 2.0\text{ A}$	$T_A = 25\text{ }^{\circ}\text{C}$	$V_F^{(1)}$	0.96	1.10	V
		$T_A = 125\text{ }^{\circ}\text{C}$		0.85	1.00	
Reverse current	Rated $V_R$	$T_A = 25\text{ }^{\circ}\text{C}$	$I_R^{(2)}$	-	5	$\mu\text{A}$
		$T_A = 125\text{ }^{\circ}\text{C}$		7.6	100	
Typical reverse recovery time	$I_F = 0.5\text{ A}$ , $I_R = 1.0\text{ A}$ , $I_{rr} = 0.25\text{ A}$		$t_{rr}$	920	-	ns
Typical junction capacitance	4.0 V, 1 MHz		$C_J$	13	-	pF

**Notes**(1) Pulse test: 300  $\mu\text{s}$  pulse width, 1 % duty cycle(2) Pulse test: Pulse width  $\leq 40\text{ ms}$ **THERMAL CHARACTERISTICS** ( $T_A = 25\text{ }^{\circ}\text{C}$  unless otherwise noted)

PARAMETER	SYMBOL	SE20FD	SE20FG	SE20FJ	UNIT
Typical thermal resistance	R <sub>θJA</sub> <sup>(1)</sup>	130			°C/W
	R <sub>θJM</sub> <sup>(1)</sup>	20			

**Note**(1) Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance  $R_{\theta JA}$  - junction to ambient;  $R_{\theta JM}$  - junction to mount**IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS**( $T_A = 25\text{ }^{\circ}\text{C}$  unless otherwise noted)

STANDARD	TEST TYPE	TEST CONDITIONS	SYMBOL	CLASS	VALUE
AEC-Q101-001	Human body model (contact mode)	$C = 100\text{ pF}$ , $R = 1.5\text{ k}\Omega$	$V_C$	H3B	$> 8\text{ kV}$

**ORDERING INFORMATION** (Example)

PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
SE20FJ-M3/H	0.015	H	3000	7" diameter plastic tape and reel
SE20FJ-M3/I	0.015	I	10 000	13" diameter plastic tape and reel
SE20FJHM3/H <sup>(1)</sup>	0.015	H	3000	7" diameter plastic tape and reel
SE20FJHM3/I <sup>(1)</sup>	0.015	I	10 000	13" diameter plastic tape and reel

**Note**

(1) AEC-Q101 qualified



**RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

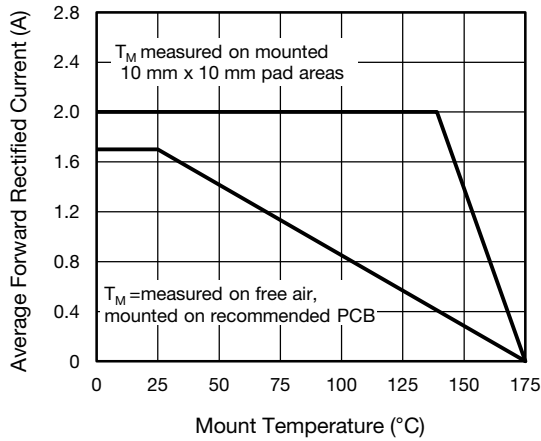


Fig. 1 - Maximum Forward Current Derating Curve

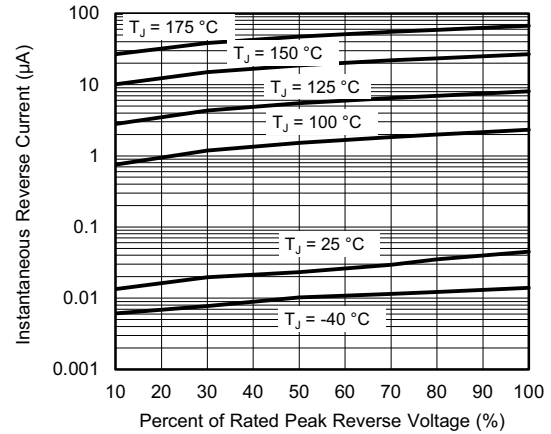


Fig. 4 - Typical Reverse Leakage Characteristics

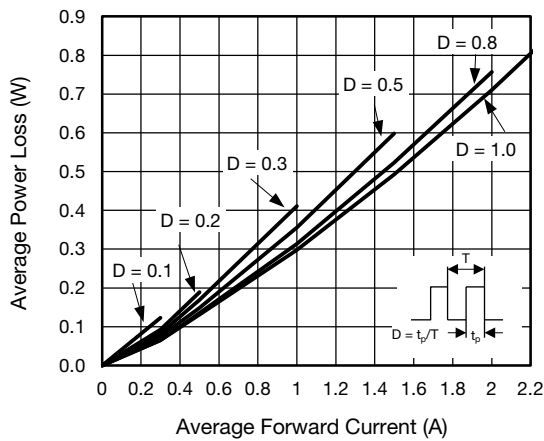


Fig. 2 - Average Power Loss Characteristics

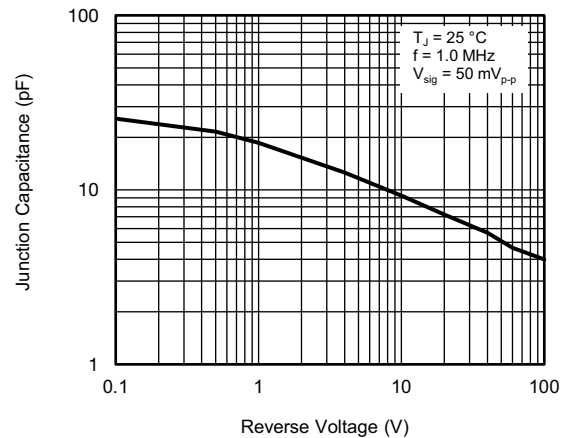


Fig. 5 - Typical Junction Capacitance

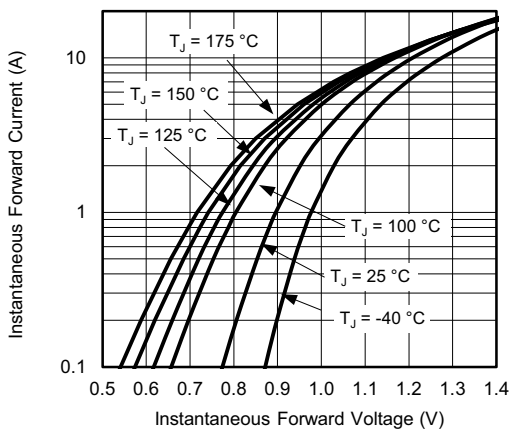


Fig. 3 - Typical Instantaneous Forward Characteristics

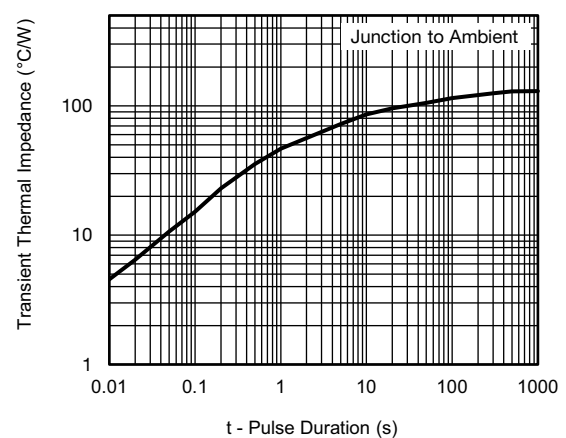
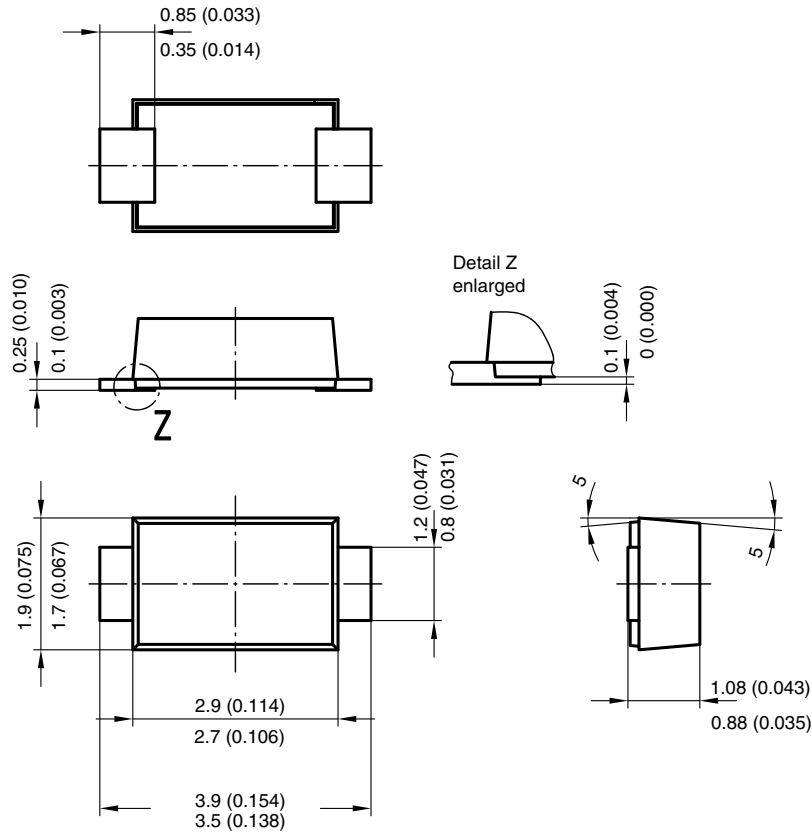


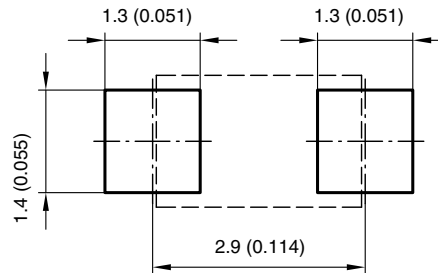
Fig. 6 - Typical Transient Thermal Impedance



**PACKAGE OUTLINE DIMENSIONS** in millimeters (inches)



Foot print recommendation:



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17247



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